

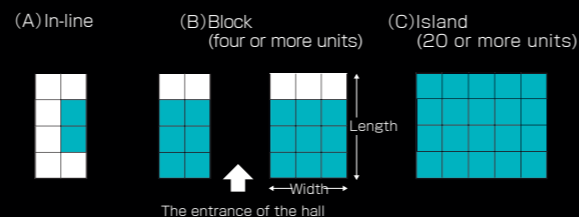
Exhibition fees

Exhibition fees	1 booth / 9m² including tax
Non-Members	Yen 442,800
Members *1	Yen 378,000
Other exhibition related expenses	
Corner charge (per corner)*2	Yen 16,200

*1 Members of the WECC member associations (CPCA, EIPC, HKPCA, IPC, IPCA, KPCA and TPCA.)
 *2 Based on the availability, corner booth is reserved.
 In-line type: 2 side open plan
 Block type: 3 side open plan

Booth type

*Based on availability



How to apply

Please fill out the Application Form in consideration with follows:

- Carefully read the "Exhibition Regulations"
- Select the exhibition based on your product

The Secretariat Office will send the invoice. Based on the invoice, please make the payment by the due date.

Deadline

Friday, February 10, 2017

Cancellation charges

If an exhibit is cancelled to suit the exhibitor's circumstances, cancellation charges (full or partial fees) shall apply as below.

Date of receipt of written notice of cancellation	Cancellation charges
By Friday, March 10, 2017	50% of booth fees
From Saturday, March 11, 2017 onward	100% of booth fees

Determination of Booth Location

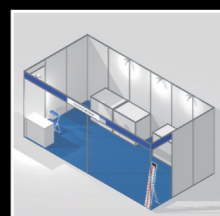
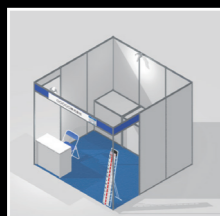
- Determined at the Exhibitors' Briefing (scheduled on March 10, 2017)
- A first-come-first-served basis (earlier applicants get priority selection) for the overlaps of desired booth location
- On behalf of absentee, The Secretariat Office selects the booth location

Package booth

We are offering cost-effective package booth including basic furnishings and ornamentation as a set.

1 booth / 1 side open plan
 Yen **81,000** (including tax)

2 booth / 1 side open plan
 Yen **127,440** (including tax)



Set item	1 booth	2 booths
Parapets	1 Set	1 Set
Carpet	9m ²	18m ²
Company name display	1 Set	1 Set
Lighting 40 W	1 light	2 lights
100W spotlights	2 lights	4 lights
Power outlet 100V	1	1
Electrical wiring	1.3Kw	1.6Kw
Reception set	1 Set	1 Set
Display stands	2 stands	4 stands
Catalog stand	1 Set	1 Set

The above prices are fees for furnishing and ornamentation only. Specifications and prices are subject to change. For the details, please refer to the Exhibitors Manual available at the Exhibitors' Briefing in March, 2017.

Schedule prior to the Exhibition

2017.2	3	4	5	6
Application deadline Friday, February 10	Exhibitors' Briefing Booth location selection meeting Friday, March 10	Sending invitations Mid-April Deadline for submission of application documents Starting registration to the exhibition Last-April		Installation period Monday, June 5 & Tuesday, June 6 Exhibition open Wednesday, June 7 to Friday, June 9

* Immediate removal on the last day

For inquiry about exhibit and application, please contact the organizer or the secretariat.

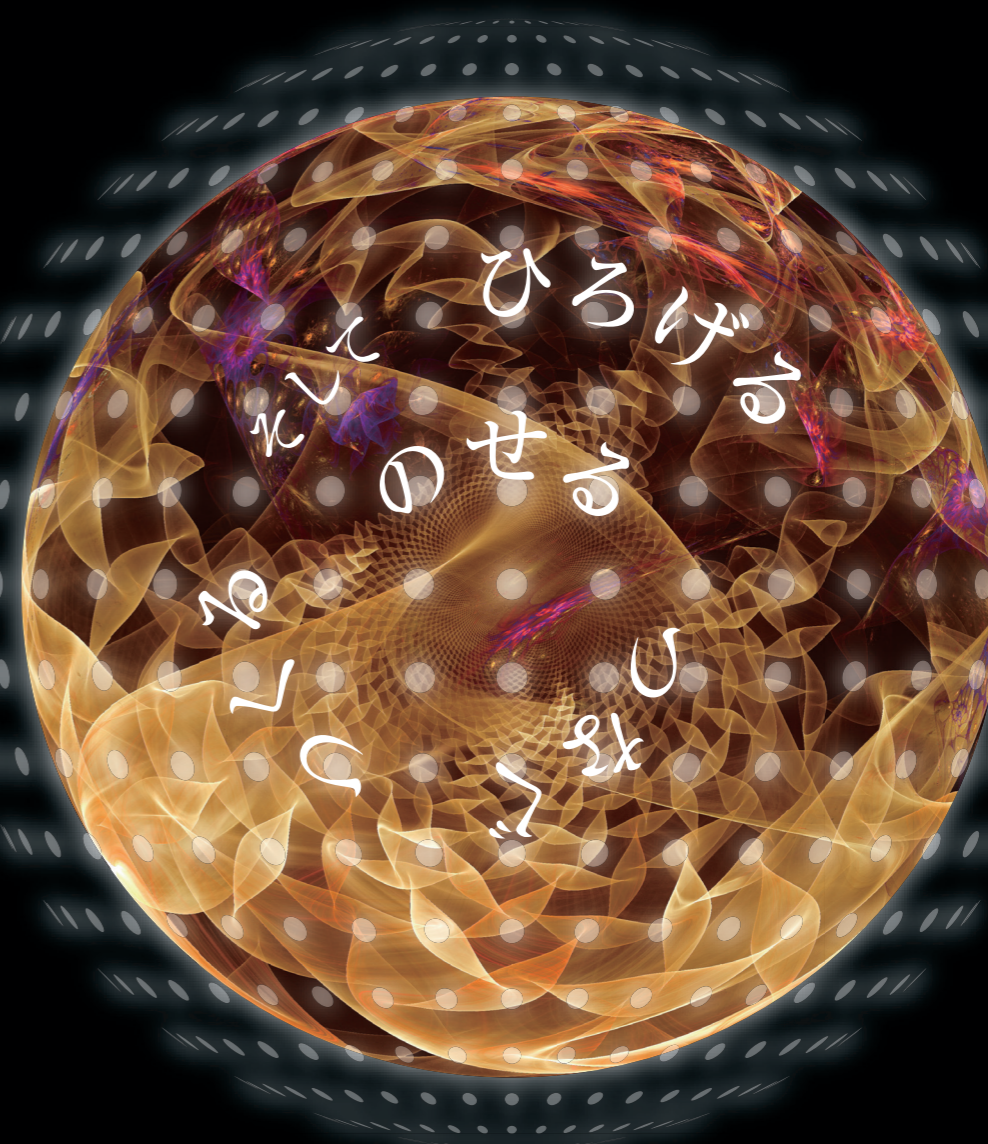
The World's top-level, Industry-Academia Collaboration

The Total Solution Exhibition 2017 for Electronic Equipment

www.jpccashow.com/en

2017
6.7 Wed. ▶ **6.9** Fri.
 Tokyo Big Sight East Hall 4-8

[The Exhibition Guide](#)



Application deadline: **February 10 (Fri.), 2017**

JPCA Show
 47th International Electronic Circuits Exhibition

JIEP Microelectronics Show
 31th Advanced Electronics Packaging Exhibition

JISSO PROTEC
 19th Jisso Process Technology Exhibition

Large Electronics Show

WIRE Japan Show
 Electronic Wire, Cable, and Connector Exhibition

Managed by

Japan Electronics Packaging and Circuits Association (JPCA)

Kairo Kaikan 2F, 3-12-2, Nishlogikita, Suginami-ku, Tokyo 167-0042
 TEL: +81-3-5310-2020 FAX: +81-3-5310-2021 E-mail: show@jpca.org

Secretariat Office

JTB Communication Design, Inc.

Celestine Shiba Mitsui Building, 3-23-1, Shiba, Minato-ku, Tokyo, Japan 105-8335
 TEL: +81-3-5657-0767 FAX: +81-3-5657-0645 E-mail: jpccashow@jtbc.com.co.jp

The Total Solution Exhibition for Electronic Equipment 2017

“Mount, Connect, Manufacture, and Expand” in The Total Solution Exhibition

- Highly specialized and focused
- Exhibition of large attendance from all over the world

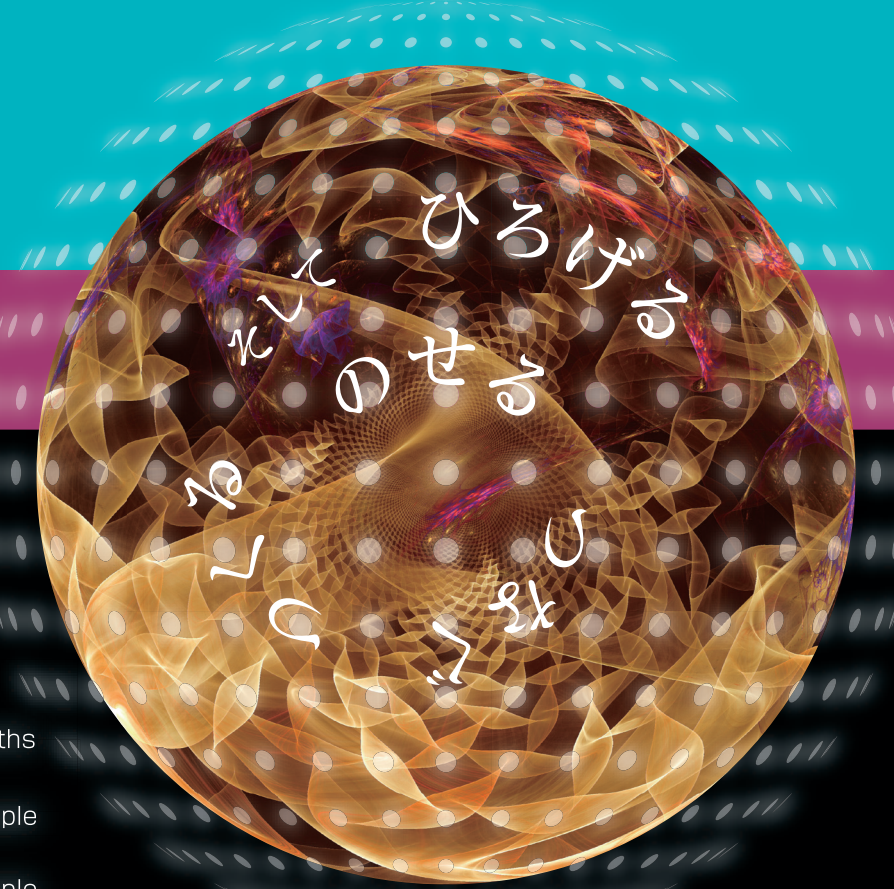
Organizers: Japan Electronics Packaging and Circuits Association, Japan Institute of Electronics Packaging, Japan Robot Association
 Co-organizers: Electronic Device Industry News (Sangyo Times, Inc.), Electric Wire & Cable News (KOGYO TSUSHIN CO., LTD)
 Sponsors (Tentative): Ministry of Economy, Trade and Industry and Kanto Head Office of Organization for Small & Medium Enterprises and Regional Innovation, JAPAN

Overseas Cooperation: World Electronic Circuits Council (WECC) Member Associates:
 China Printed Circuit Association (CPCA), European Institute of Printed Circuits (EIPC), Hong Kong Printed Circuit Association (HKPCA), IPC-Association Connecting Electronics Industries (IPC), Indian Printed Circuit Association (IPCA), Korea Printed Circuit Association (KPCA), Taiwan Printed Circuit Association (TPCA)

Entrance fee:
1,000 yen (including tax)

*Free Admission for visitors with invitations and those who have preregistered online.

2017 6.7 Wed. ▶ 6.9 Fri. East Hall 4 - 8, Tokyo Big Sight



High repeat rate

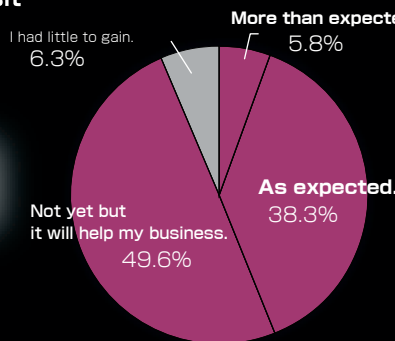
High satisfaction of visitors means high satisfaction of exhibitors

1 Reasons for choosing this exhibition from various electronics exhibitions



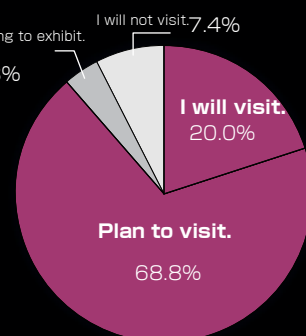
2 Result of visit

More than 90% of visitors realized successful result.



3 Plan of visit to the next exhibition

* (1) : Exhibitors' questionnaire
 *(2)(3)(4) : Visitors' questionnaire



Result of 2016

Exhibition expanding for three consecutive years and gaining high expectations from both Japan and foreign countries

Scale
 760 companies / 1,421 booths
Number of visitors 40,428 people
Seminar audiences 11,502 people

Engineers' visit

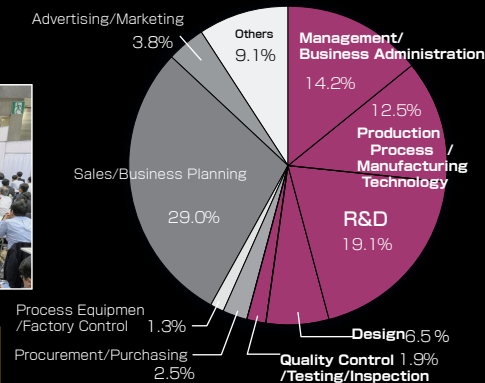
Technically advanced seminar programs

More than 250 sessions including the keynote speech with an audience of approx. 2,000 people

- Keynote speech (1,999 people)
- Best manufacturing seminar (962 people)
- JIEP Advanced Electronics Packaging (JISSO) Technology Symposium (622 people)
- PROTEC Seminar (700 people)



4 Classification of visitors' job



Main companies visiting the exhibition

- **Automotive:** Aisin Seiki, Asahi Denso, Calsonic Kansai, DENSO, Fuji Heavy Industries, Hino Motors, Hitachi Automotive Systems, Honda Motor, ICHIKOH INDUSTRIES, Keihin, KOITO MANUFACTURING, Mazda Motor, Mitsubishi Electric, NHK SPRING, NISSAN MOTOR, Panasonic, PIONEER, STANLEY ELECTRIC, Sumitomo Wiring Systems, TOKAI RIKKA, Toyodense, TOYOTA MOTOR, VSN, Yazaki Parts
- **Aircraft/Aerospace:** NEC Space Technologies, JAXA (Japan Aerospace Exploration Agency), Mitsubishi Electric, Mitsubishi Heavy Industries, NEC, Nippon Avionics, Panasonic, SINFONIA TECHNOLOGY
- **Office Automation / Industry:** Canon, FANUC, Fuji Xerox, Mitsubishi Electric, OMRON, Panasonic, Panasonic Factory Solutions, Ricoh Industry Company, RICOH JAPAN, SANYO DENKI, TOSHIBA, YASKAWA Electric
- **IT/Communication:** Fujikura, FUJITSU, FUJITSU Advanced Technologies, FUJITSU LABORATORIES, Fujitsu Quality Laboratory, Hitachi, Huawei, IBM, KDDI, KYOCERA, Murata Manufacturing, NEC, NTT, Oki Electric Industry, Panasonic
- **Consumer:** Canon, CASIO COMPUTER, FUJITSU GENERAL, LG, Nikon, Panasonic, Pioneer, Samsung, Sharp, Sony, Sony Global Manufacturing & Operations, Sony Semiconductor Solutions, TOSHIBA
- **Medical/Instruments:** Hitachi High-Technologies, Hitachi Medical, J.MORITA TOKYO MFG, MARK ELECTRONICS, Olympus, SHIMADZU, SHIRAKAWA OLYMPUS, Siemens, TERUMO, TOSHIBA MEDICAL SYSTEMS
- **Electronics circuits board:** CMK, DAISHO DENSHI, Eastern, ELNA, Fujikura, FUJITSU INTERCONNECT TECHNOLOGIES, Hitachi Chemical Company, IBIDEN, KYOCERA, Kyoden, Kyoel Sangyo, KYOSHA, Meiko Electronics, NIPPON MEKTRON, Nitto Denko, Panasonic, RISHO KOGYO, SHINKO, SHINKO ELECTRIC INDUSTRIES, Shirai Electronics Industrial, Sumitomo Electric Printed Circuits, Yamashita Materials

Organized by: Japan Institute of Electronics Packaging (JIEP)
 Organized by: Japan Robot Association (JARA) and others
 * Result of previous year

The number of visitors who were engaged in management, manufacturing technology, R&D, design and manufacturing accounted for more than half of the total.

Concurrent Exhibitions and Categories



47th International Electronic Circuits Exhibition

● **PWB Technology**
 Printed wiring boards, Design process technologies, Materials for wiring boards, Manufacturing process technologies, distribution of equipment and materials, and environmental systems

● **Module Japan**
 Module substrate, Module mounting, Design, Module substrate / packaging materials, Manufacturing process technologies and equipment and materials, Distribution and environmental systems

● **Flexible Printed Circuits Products Area**
 Printed wiring mount board, Mounted module substrate, Manufacturing, mounting, assembling, and inspection contract services of various kinds of integrated circuits

● **Monotsukuri Fiesta**
 3D-MID Pavilion/Shaping the Dream Supporting Exhibition for the Next Application/
 Pavilion of local governments (Tentative)



31th Advanced Electronics Packaging Exhibition

ALL high-density mounting technologies
 Academic Plaza
 eX-tech



19th Jisso Process Technology Exhibition

Electronic component placement machines and related equipment
 and systems, Semiconductor packaging machines and systems,
 inspection / test equipment, Packaging design systems



Large Electronics Show

● **PE PROCESS**
 ● **Components, MEMS/Sensor Exhibition**
 ● **LED/OLED Exhibition, Organic Semiconductor Exhibition**
 Various printed electronics, parts and MEMS/sensor, application products related to LED/OLED and organic semiconductor, materials, equipment, system, design and analysis system, inspection and evaluation measuring technology, etc.



Electronic Wire, Cable, and Connector Exhibition

Industrial equipment, Wires, cables, and connectors, Electric wire processors, wiring member, and wire harness, Electric wire or cable measuring instrument, Manufacturing equipment (wire, cables, and harness), Inspection equipment

NEW

● **IoT Electronics Packaging Exhibition**

● **Wearable Electronics Packaging Exhibition**

Newly set in the zone between JPCA Show and Large Electronics Show